

# Timepix3 based Detectors

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# Outline

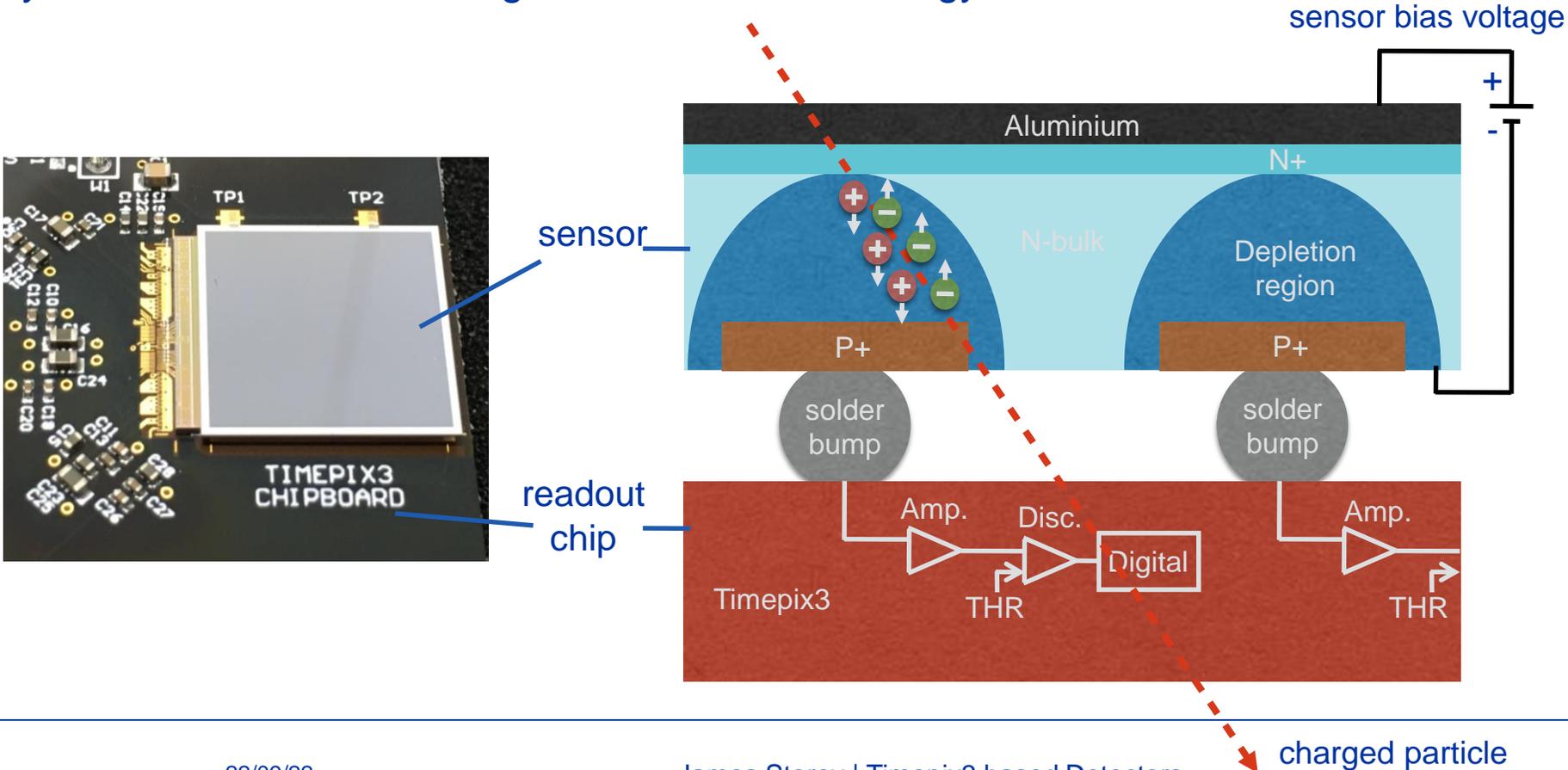
1. Brief introduction to Timepix3 & 4 Hybrid Pixel Detectors (HPD's)
2. Example applications of particle detection with Timepix3 HPD for Beam Instrumentation at CERN:
  - Rest gas ionisation profile monitor ( electron detection )
  - Beam Gas Vertex & Fast Beam Loss Monitor ( high energy charged particle detection )

# Hybrid pixel detector

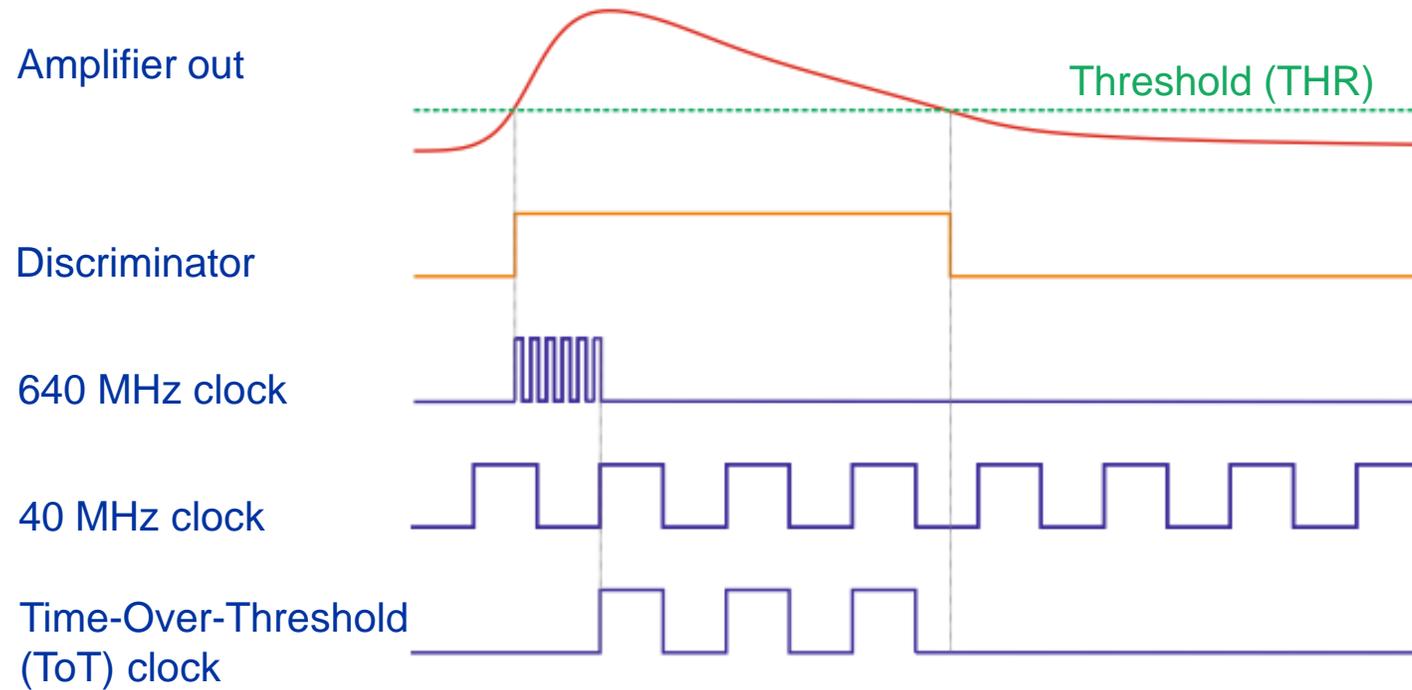
**Hybrid Pixel Detector (HPD):** Pixelated sensor bump bonded to a pixelated readout chip.

**Sensor:** 2-dimensional array of PN-diodes processed (for example) in high-resistivity silicon.

**Readout chip:** array of readout channels designed in CMOS technology.



# Timepix3 response to charge



**minimum  
threshold = 500 e<sup>-</sup>  
(1.8 keV)**

**time  
resolution =  
1.5625 ns**

Amplifier out > threshold

→ **Event**

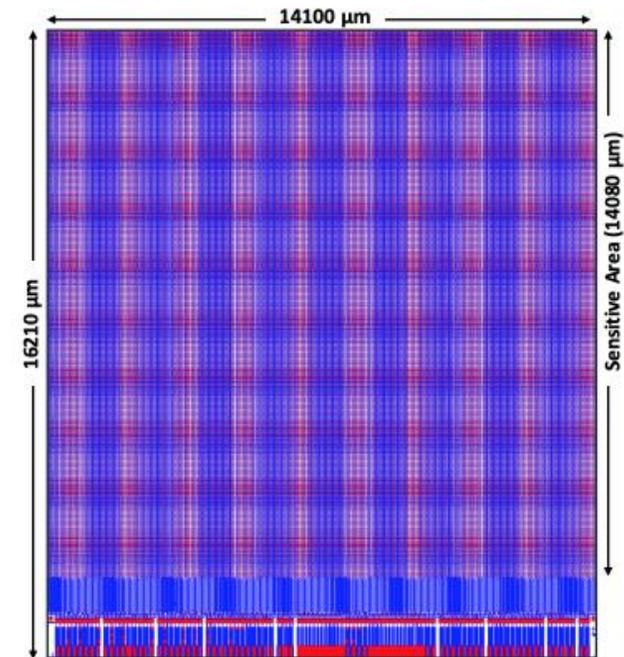
Each **event** consist of:

- Pixel position → **Where**
- Time of Arrival (ToA) → **When**
- Time-Over-Threshold (ToT) → **Energy**

**Max.  
80M events / s**

# Timepix3 specifications

Application	General Purpose particle tracking
Technology	IBM 130nm
Pixel	(h <sup>+</sup> /e <sup>-</sup> ) with 55 x 55 μm <sup>2</sup>
Pixel arrangement	256 x 256 (2x4 superpixels)
Acquisition modes	1) Time (TOA) AND Charge (TOT) 2) Time (TOA) 3) PC & integral charge (iTOT)
Readout Type	1) Data driven (Shutter-less) 2) Frame-based (Shutter)
Thresholds	1
Minimum threshold	> 500 e <sup>-</sup>
Time resolution (TOA)	1.562 ns
Energy Resolution (TOT)	~2 keV FWHM (Si)
Power consumption	<1.5W @1.5 V
Floorplan	3 sides buttable and minimum periphery
TSVs possibility	YES. With 1.2mm periphery
Count Rate	Data-Driven: ~0.43 x 10 <sup>6</sup> hits/mm <sup>2</sup> /s Frame-based: 826 x 10 <sup>6</sup> hits/mm <sup>2</sup> /s
Output bandwidth	1 to 8 SLVS DDR @640Mbps each



Slide from Xavier Llopart - EP Detector Seminar on 11<sup>th</sup> Feb. 2022 (<https://indico.cern.ch/event/1121147/>)

# Applications of Timepix HPD's

## High Energy Physics (HEP):

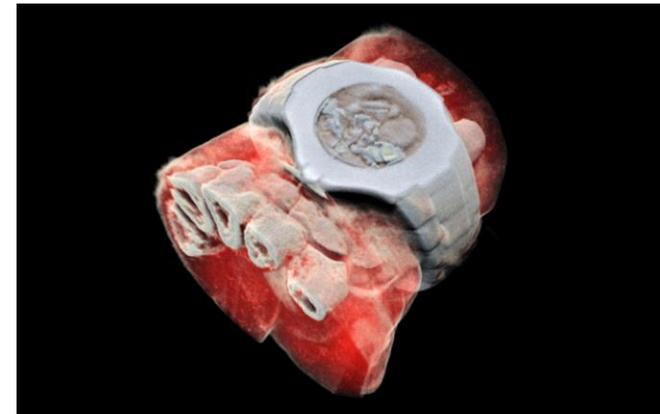
- Charged particle tracking (e.g. Telescope, TPC, etc.)
- Neutron detection (e.g. Converter + MCP + Timepix3 )
- Electron detection
  - **Beam instrumentation**
- X-ray detection

## Outside HEP:

- Dosimetry
- Time-of-flight mass spectroscopy
- Electron microscope
- Compton cameras
- Education

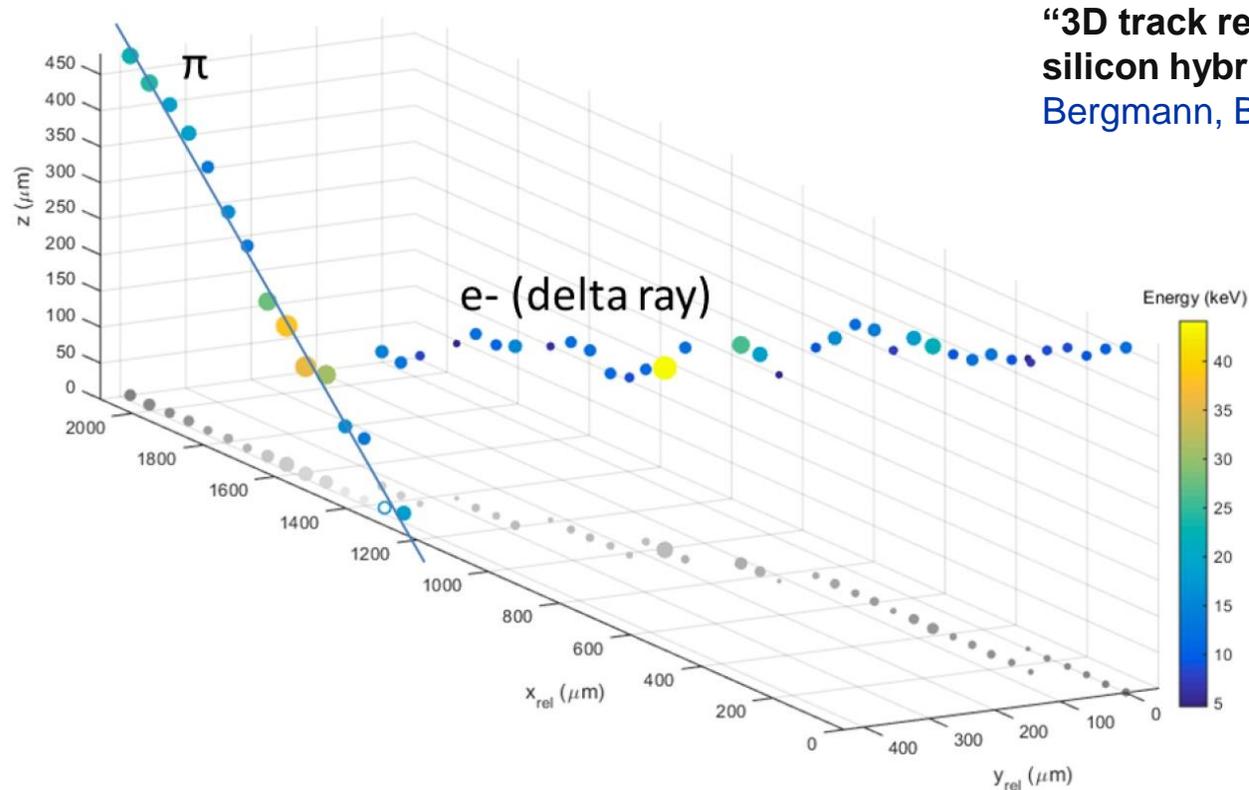


Space dosimetry - Timepix on International Space Station  
(Courtesy of NASA, photo ref. no. iss036e006175)



Spectral CT X-ray image  
(Courtesy of MARS Bioimaging Ltd.)

# Example Timepix3 application: 3D particle tracking



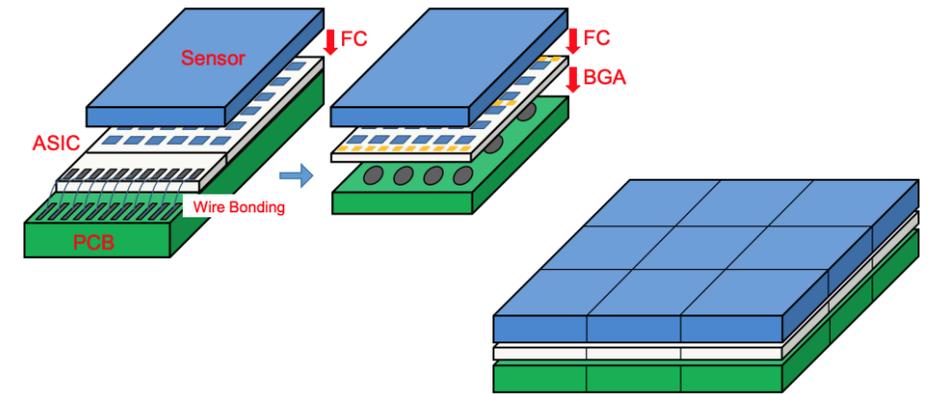
“3D track reconstruction capability of a silicon hybrid active pixel detector,”  
Bergmann, B. et al. Eur. Phys. J. C (2017)

- Timepix3 with 500um p-on-n silicon sensor irradiated by 120 GeV/c pion beam at 60 degree.
- Depth ( $z$ -axis) information inferred from Time-of-Arrival information → **3D particle tracking**

# Timepix4 specification

		Timepix3 (2013)	Timepix4 (2019)		
<b>Technology</b>		130nm – 8 metal	65nm – 10 metal		
<b>Pixel Size</b>		55 x 55 $\mu\text{m}$	55 x 55 $\mu\text{m}$		
<b>Pixel arrangement</b>		3-side buttable 256 x 256	4-side buttable 512 x 448	<b>3.5x</b>	
<b>Sensitive area</b>		1.98 $\text{cm}^2$	6.94 $\text{cm}^2$		
<b>Readout Modes</b>	Data driven (Tracking)	Mode	TOT and TOA		
		Event Packet	48-bit	64-bit	<b>33%</b>
		Max rate	0.43x10 <sup>6</sup> hits/mm <sup>2</sup> /s	<b>3.58x10<sup>6</sup> hits/mm<sup>2</sup>/s</b>	<b>8x</b>
	Frame based (Imaging)	Max Pix rate	1.3 KHz/pixel	<b>10.8 KHz/pixel</b>	
		Mode	PC (10-bit) and iTOT (14-bit)	CRW: PC (8 or 16-bit)	
		Max count rate	~0.82 x 10 <sup>9</sup> hits/mm <sup>2</sup> /s	~5 x 10 <sup>9</sup> hits/mm <sup>2</sup> /s	<b>6x</b>
<b>TOT energy resolution</b>		< 2KeV	< 1KeV	<b>2x</b>	
<b>Time resolution</b>		1.56ns	<b>195.3125ps</b>	<b>8x</b>	
<b>Readout bandwidth</b>		≤5.12Gb (8x SLVS@640 Mbps)	≤163.84 Gbps (16x @10.24 Gbps)	<b>32x</b>	
<b>Target global minimum threshold</b>		<500 e <sup>-</sup>	<500 e <sup>-</sup>		

## 4-side buttable



Timepix4 HPD's can be combined to form (infinitely) large detector areas

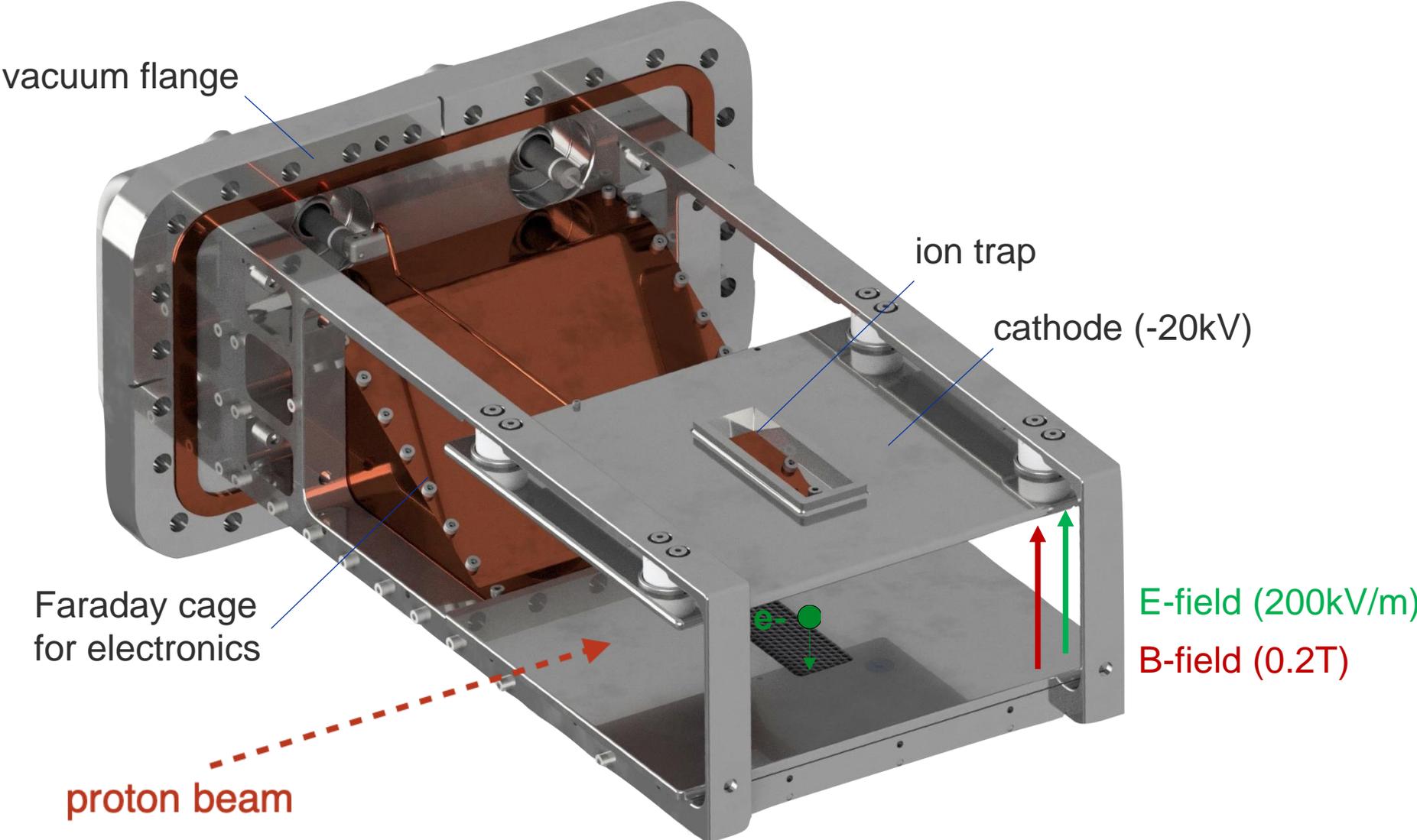
Slide from Xavier Llopart - EP Detector Seminar on 11<sup>th</sup> Feb. 2022 (<https://indico.cern.ch/event/1121147/>)

# Examples of 1) electron & 2) high energy charged particle detection with Timepix3/4 based detectors for Beam Instrumentation

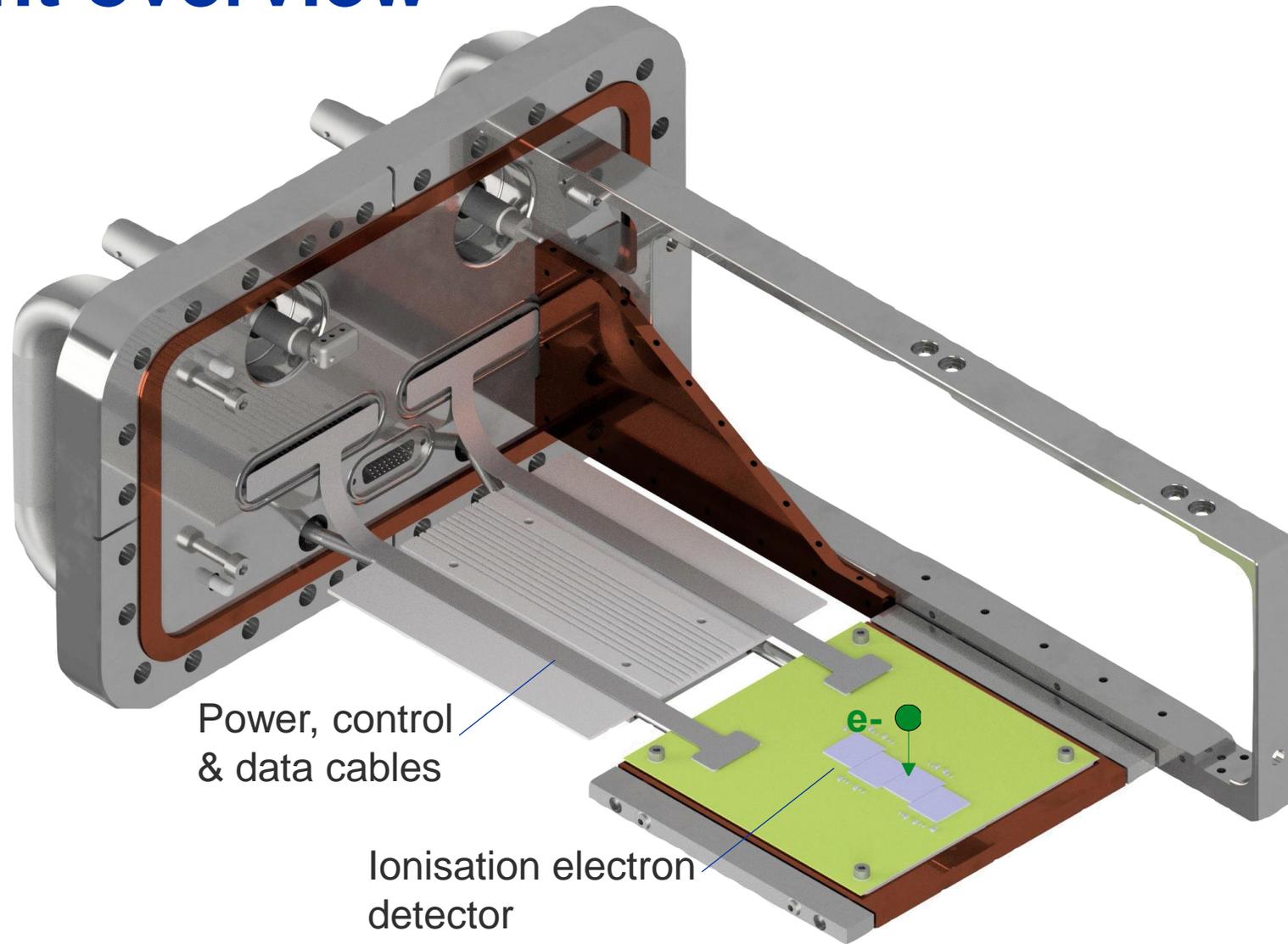
# 1. Example of electron detection with Timepix3 HPD

# Instrument overview

Measures beam profile in horizontal plane (  $x, s$  ) – second instrument design for vertical plane measurement



# Instrument overview



# Ionisation electron detector based on Timepix3 HPD

## Ionisation electron detector requirements

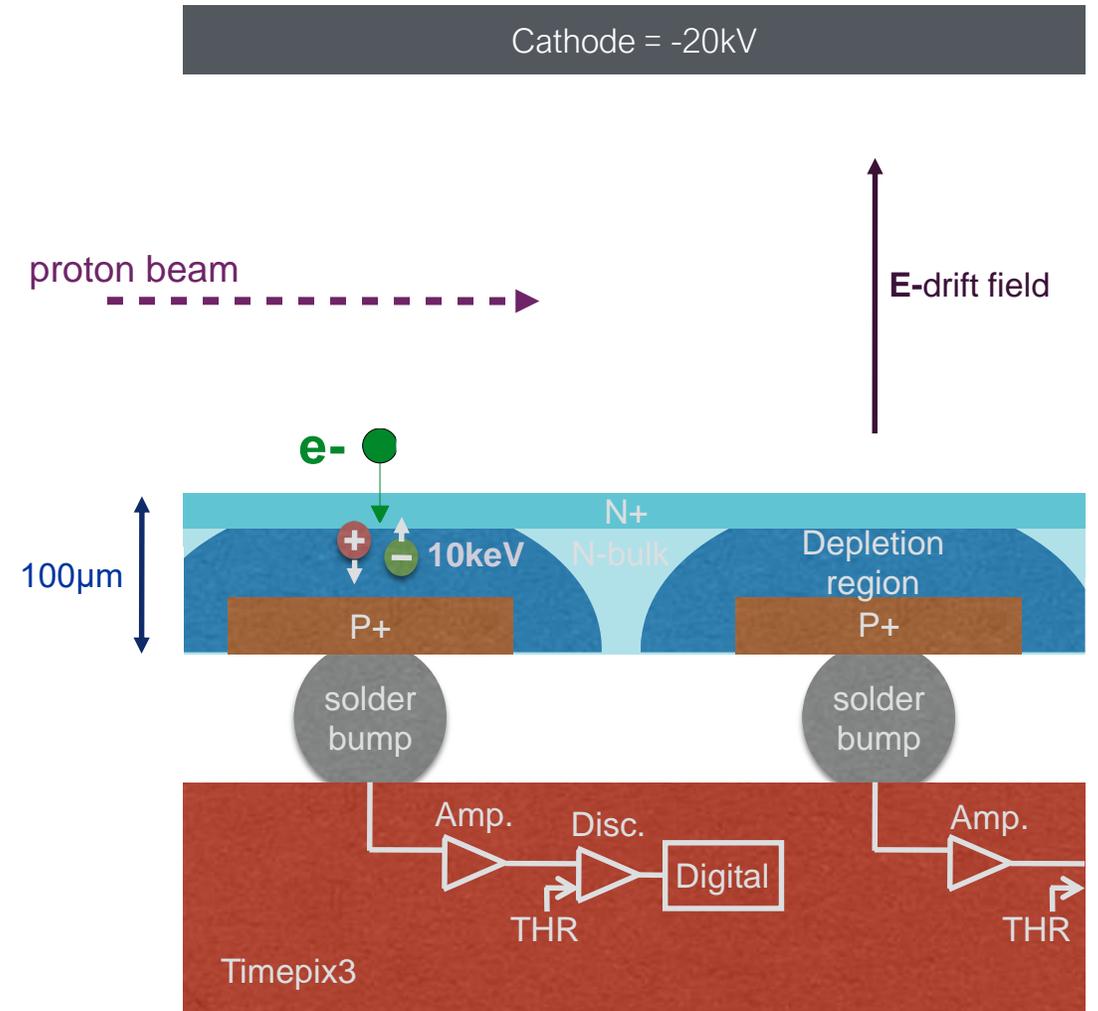
- Detect 10keV electrons (penetration depth in silicon = 1.5 $\mu$ m)
- Detect each electron with time resolution < 25ns & spatial resolution < 100 $\mu$ m
- Meet outgassing requirements for installation in the UHV of the PS beam pipe
- Operate during the acceleration cycle

## Sensor

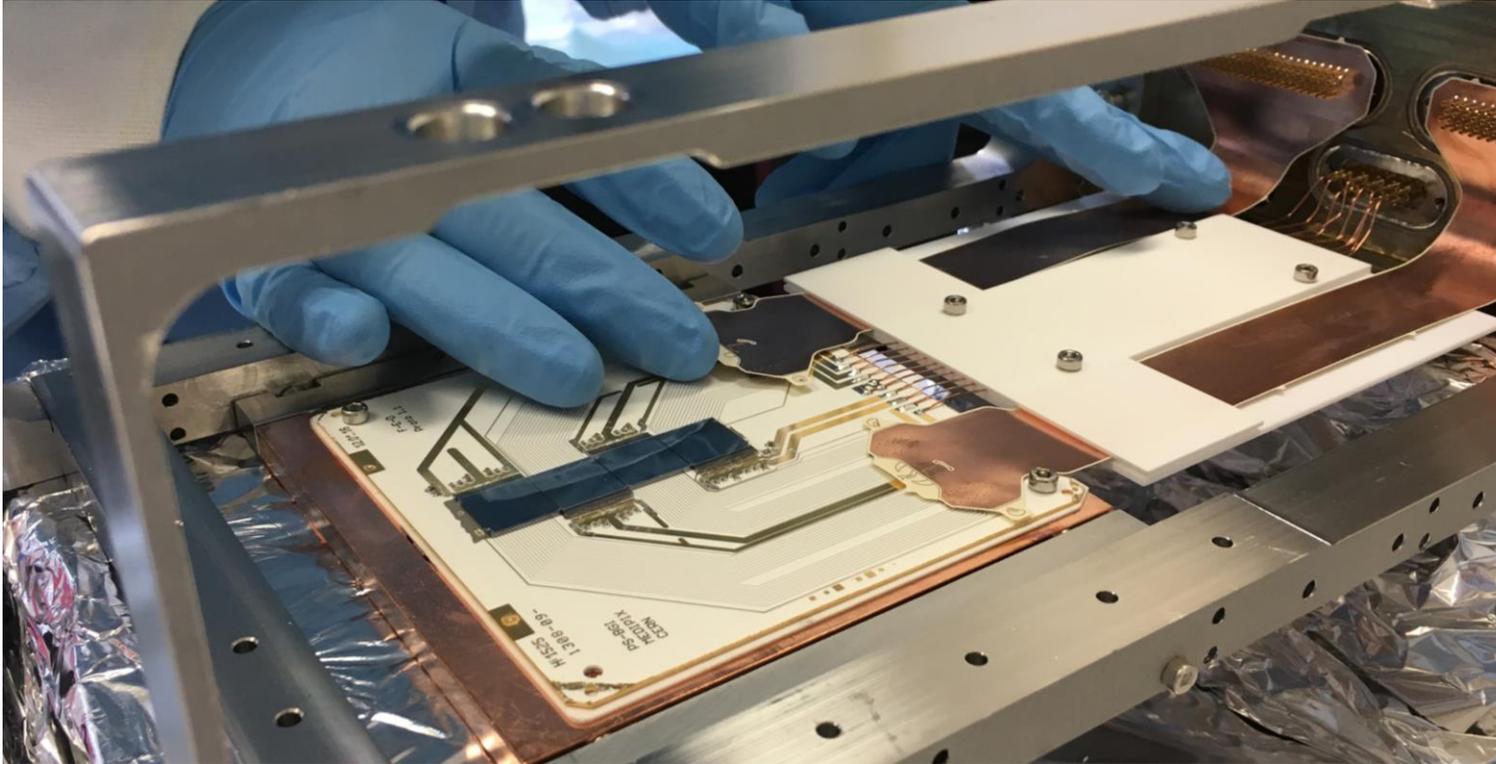
- **Non-metalized**, p-in-n, 100 $\mu$ m deep
- 256 x 256 array of PN-diodes
- Pixel size = 55 $\mu$ m x 55 $\mu$ m
- Sensor area = 14mm x 14mm

## Timepix3 readout chip

- Each sensor pixel is connected to an individual readout channel (pixel)



# Ionisation electron detector – Prototype



## Ceramic carrier board

- 2 metal layers,  $\text{Al}_2\text{O}_3$  substrate
- 4 x Timepix3 HPD's attached with Staystick 672 and wire bonded
- Sensor bias wire glued (Mk.1) / wire bonded to Al pad (Mk.2)

## Flexible cables

- Connects ceramic board to electrical feedthroughs on vacuum flange
- Two metals layers with a Liquid Crystal Polymer (LCP) substrate

Qualified for installation in the PS accelerator beam pipe

# Installation in the CERN PS

0.2T self-compensating triplet dipole magnet (Dominique Bodart TE-MS-C) & instrument vacuum chamber



Instrument prior to installation



Installation at PS SS82



Vacuum pump down:

- $1 \times 10^{-8}$  mbar after 24 hours
- **$2 \times 10^{-10}$  mbar steady state**

# Selecting ionisation electrons

## Signal – ionisation electrons:

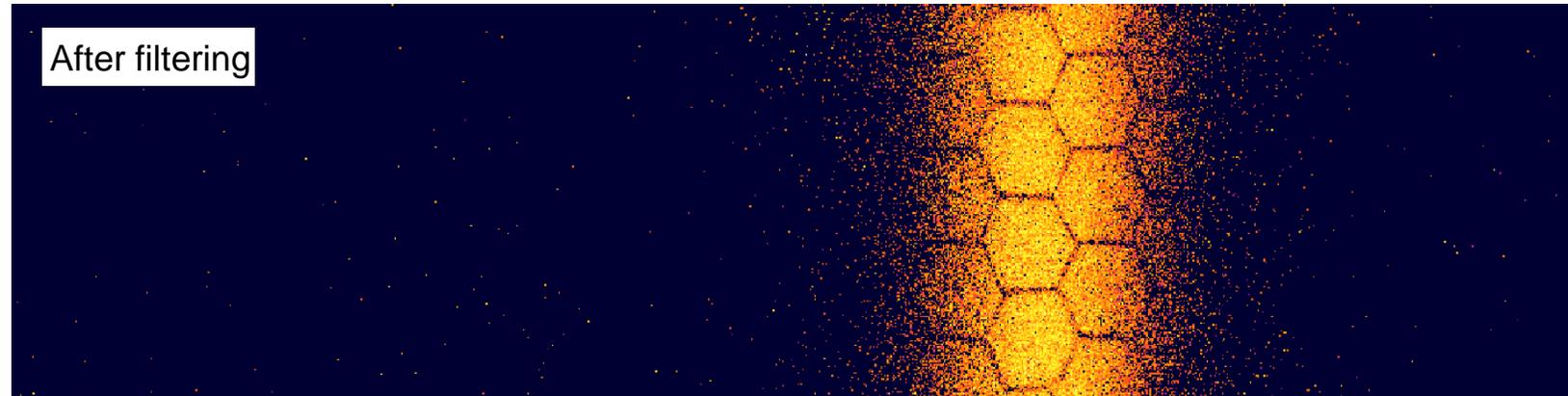
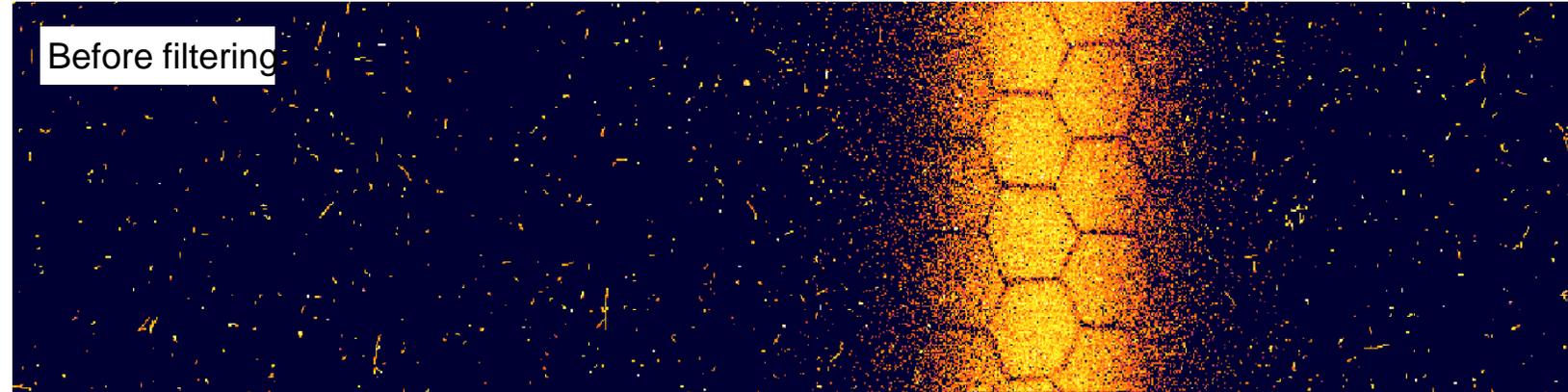
- Mostly single pixel events
- Energy < 10keV

## Background – shower of secondary particles due to beam loss:

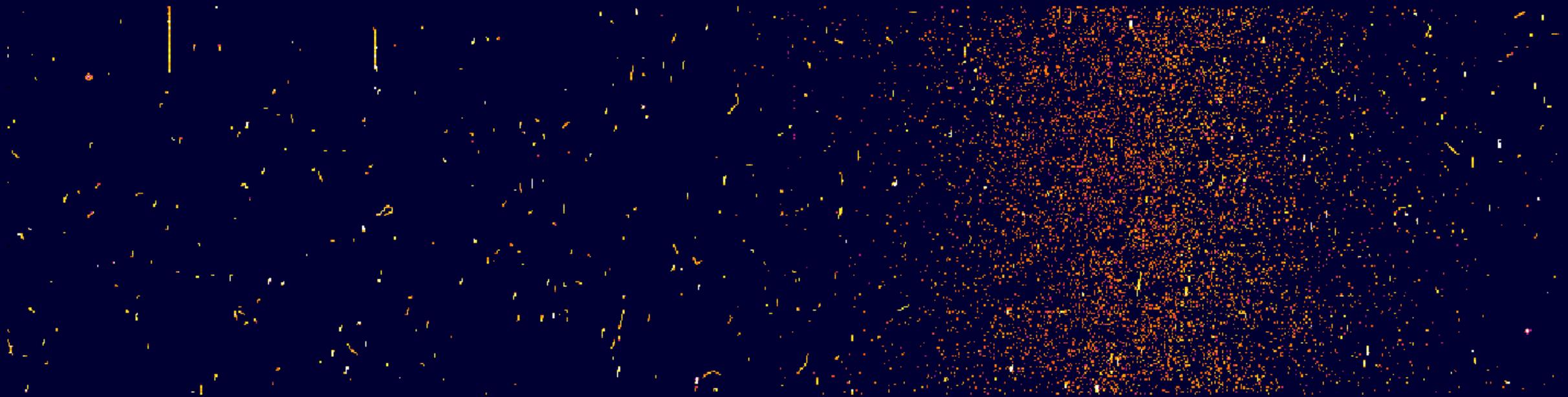
- Multi-pixel events
- Energy > 26keV

## Signal selection:

- Cluster finding to identify particle events
- Size & energy criteria to select ionisation electrons



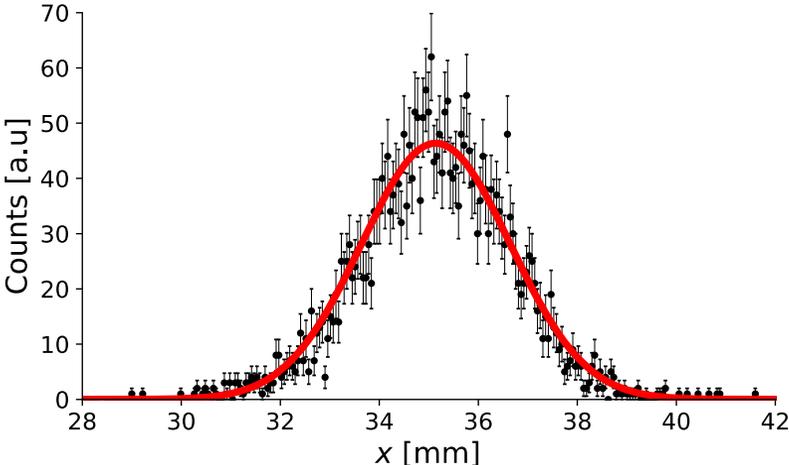
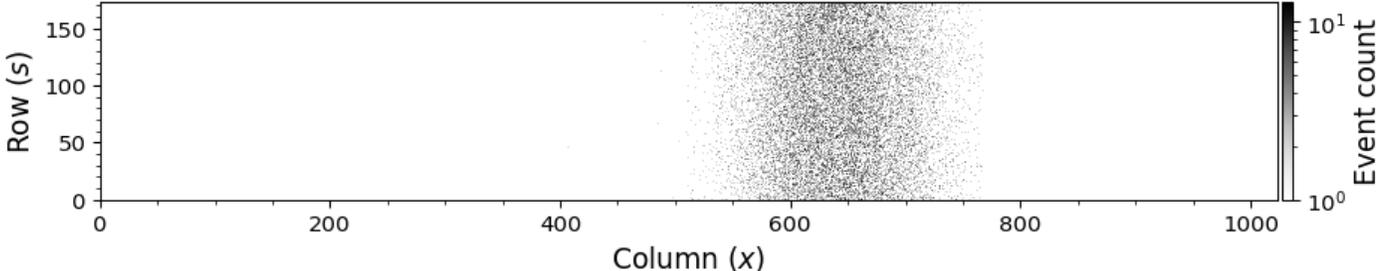
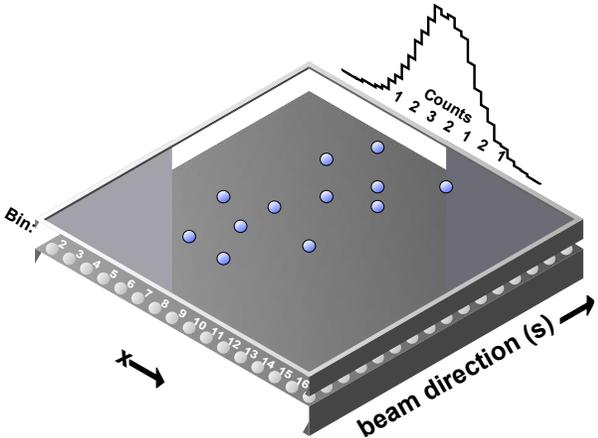
# Preparation of LHC beam in the PS



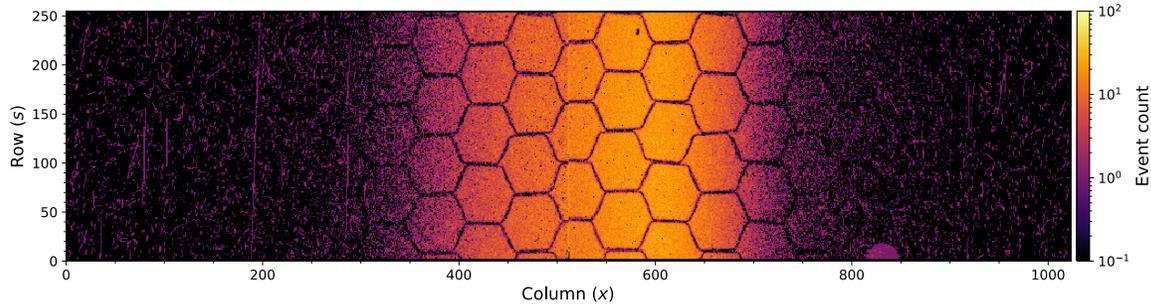
- Timepix3 data-driven readout enables "live" display of the beam throughout the cycle
- 1.5 seconds in real time: slowed down here for viewing purpose
- Each frame is 10 ms of data
- Not filtered: *background particles are interesting to look at!*
- LHC type beam, single bunch (  $I = 20 \times 10^{10}$  p )

# Beam profile measurement

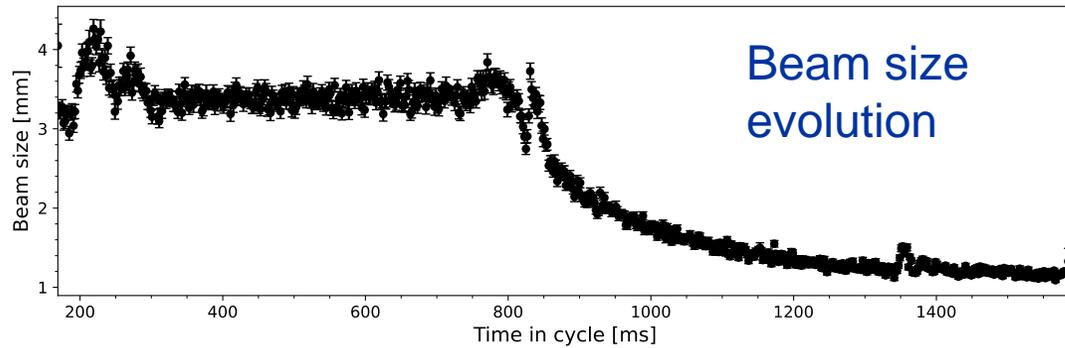
Compute beam profile by summing counts in each column



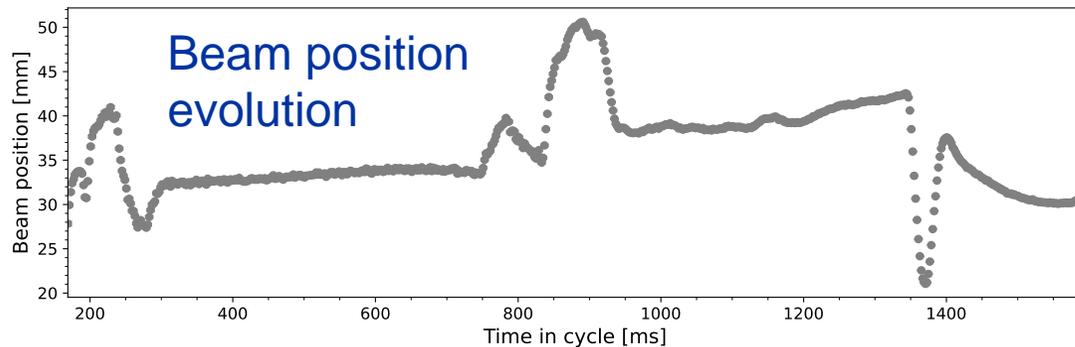
# Single bunch measurements



Single bunch in the PS at the start of beam commissioning

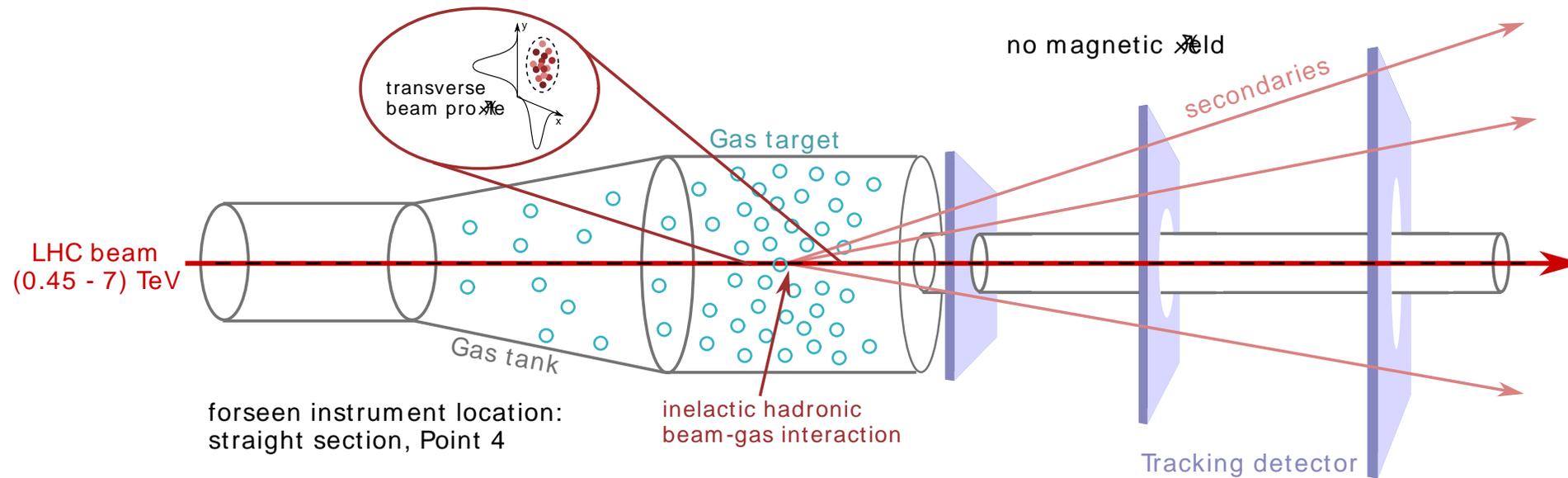


Continuous & non-destructive measurement of of beam size and position throughout the PS cycle (1.2s)



## 2. Examples of high energy charged particle detection

# Beam Gas Vertex (BGV) profile monitor for HL-LHC

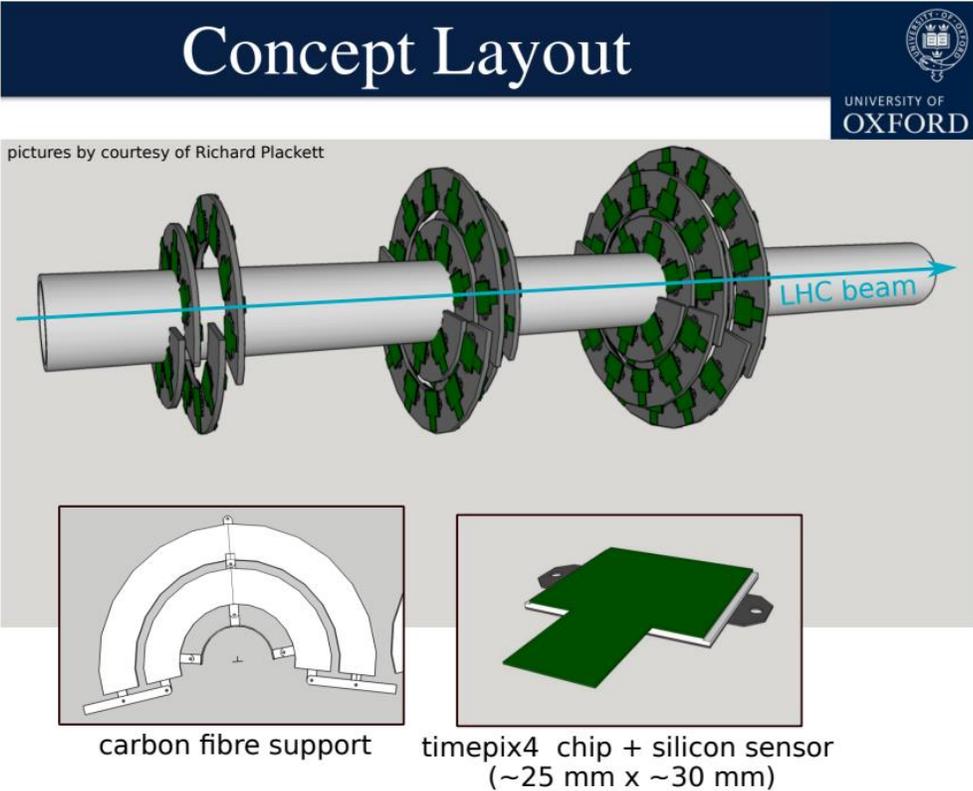


BGV consists of: 1) **Gas target** & 2) **Forward tracking detector**

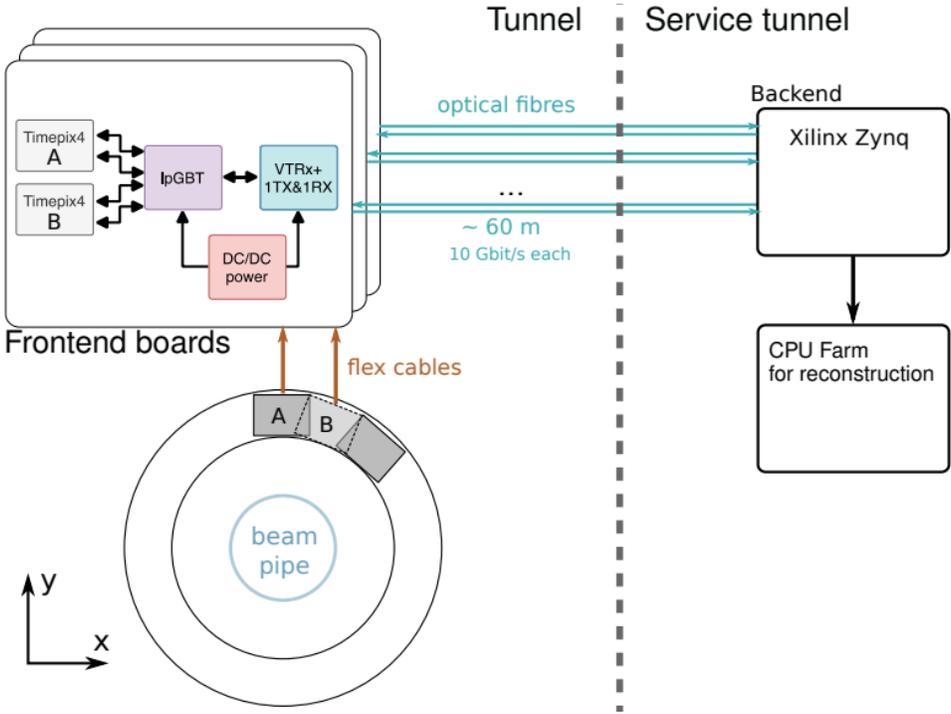
Beam profile inferred from density of the reconstructed primary vertices of the inelastic beam gas interactions.

# BGV - Tracking detector based on Timepix4 Hybrid Pixel Detectors

Tracking detector – modules + support  
( Collaboration with Oxford University )



Tracking detector – readout + processing  
( CERN )

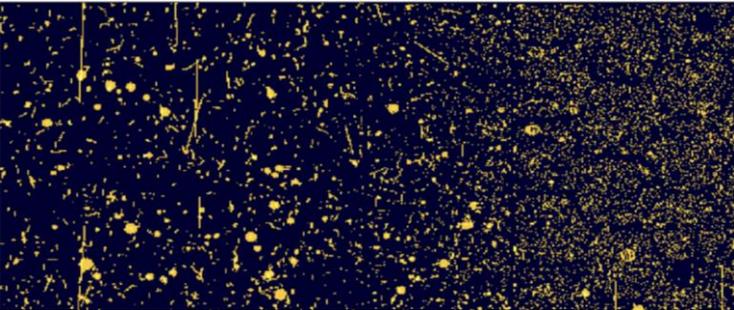


Architecture based on BIPXL readout developed for PS BGI

# Fast Beam Loss Monitor (BLM) based on Timepix3

Operational need: Fast beam loss monitor for rapid deployment in the LHC

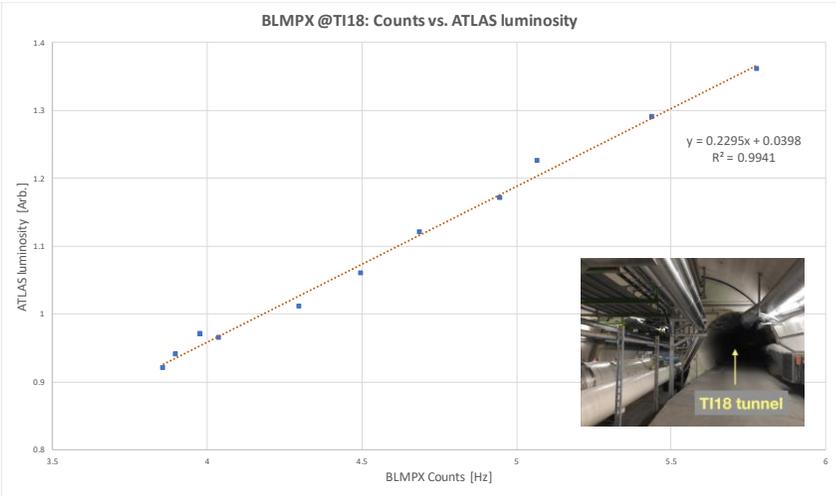
**Timepix3-BLM** = Timepix3 HPD + BIPXL readout systems ( minimal amount of development )



Beam loss in the PS at injection as seen by PS BGI



Radiation tolerant Fast BLM based on Timepix3 with BIPXL readout



Measurement for FASER at TI18 – 2 hour installation

# Summary

Timepix (& Medipix) family of Hybrid Pixel Detectors (HPD's) are an incredibly versatile tool for charged & neutral particle detection across a wide range of energies.

Diverse and well established community of users.

Very happy to discuss possible applications in the context of FCC EPOL...